CMOS 8-Bit Microcontroller

TMP88PS38N/F

The TMP88PS38 is the high-speed and high performance 8-bit signal chip microcomputers which built in a program storage area (64 Kbytes), an OSD font storage area (24 Kbytes) and the One-Time PROM of vector table storage area (256 bytes). The TMP88PS38 is pin compatible with the TMP88CS38. The operation possible with the TMP88PS38 can be performed by writing programs to PROM. The TMP88PS38 can write and verify in the same way as the TC571000D an EPROM programmer.

Product No.	OTP	RAM	Package	Adaptor Socket
TMP88PS38N	64 Kbytes (256 bytes)	2 Khystos	P-SDIP42-600-1.78	BM11174
TMP88PS38F	24 Kbytes	2 Kbytes	P-QFP44-1414-0.80D	BM11175

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For a discussion of how the reliability of microcontrollers can be predicted, please refer to Section 1.3 of the chapter entitled Quality and Reliability Assurance / Handling Precautions.

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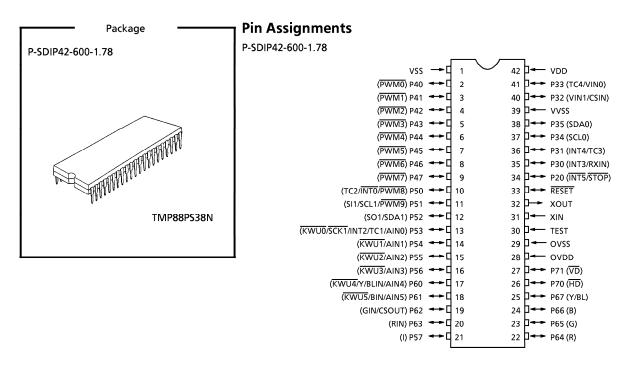
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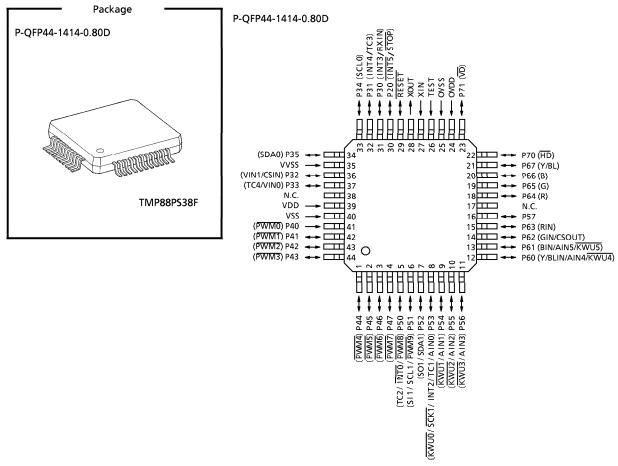
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> 2002-10-25 3-38-208





Operational Description

The configuration and function of the TMP88PS38 are the same as those of the TMP88CS38, except in that a one-time PROM is used instead of an on-chip mask ROM.

1. Operation Mode

The TMP88PS38 has two mode: MCU and PROM.

1.1 MCU Mode

The MCU mode is activated by fixing the TEST/VPP pin at low level. In the MCU mode, operation is the same as with the TMP88CS38.

1.1.1 Program Memory

The TMP88PS38 has a 64 Kbytes (addresses 04000_H to $13EFF_H$ in the MCU mode, addresses 10000_H to $1FEFF_H$ in the PROM mode) of program storage area, 24 Kbyte (addresses 20000_H to $25FFF_H$ in the MCU mode, addresses $0A000_H$ to $0FFFF_H$ in the PROM mode) and 256 byte (addresses $1FF00_H$ to $1FFFF_H$ in the PROM mode) one-time PROM of vector table storage area.

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Electrical Characteristics

Absolute maximum ratings

 $(V_{SS} = 0 V)$

Parameter	Symbol	Pins	Ratings	Unit
Supply Voltage	V _{DD}	_	- 0.3 to 6.5	
Programmable Voltage	V_{pp}	TEST/V _{PP} Pin	- 0.3 to 13.0	v
Input Voltage	V _{IN}	_	- 0.3 to V _{DD} + 0.3	ď
Output Voltage	V _{OUT1}	_	- 0.3 to V _{DD} + 0.3	
Output Current (Per 1 pin)	I _{OUT1}	Ports P2, P3, P4, P5, P64 to P67, P7	3.2	
	I _{OUT2}	Ports P60 to P63	30	mA
	Σ I _{OUT1}	Ports P2, P3, P4, P5, P64 to P67, P7	120	
Output Current (Total)	Σ I _{OUT2}	Ports P60 to P63	120	
Power Dissipation [Topr = 70°C]	PD	_	600	mW
Soldering Temperature (time)	Tsld	_	260 (10 s)	
Storage Temperature	Tstg	_	– 55 to 125	°C
Operating Temperature	Topr	_	– 30 to 70	

Note: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

Recommended operating conditions

 $(V_{SS} = 0 \text{ V, Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Pins	Co	nditio	ns	Min	Max	Unit
			fc = 16 MHz	c = 16 MHz NORMAL mode				
Supply Voltage	V_{DD}	_	fc = 16 MHz	IDLE n	node	4.5	5.5	
			_	STOP	mode			
Innut High Valtage	V _{IH1}	Except hysteresis input	V 45+-55V		$V_{DD} \times 0.70$	V] _v	
Input High Voltage	V _{IH2}	Hysteresis input	V _{DD} = 4.5 to 5.5 V			$V_{DD} \times 0.75$	V_{DD}	
	V _{IL1}	Except hysteresis input	V _{DD} = 4.5 to 5.5 V V _{DD} = 4.5 to 5.5 V			$V_{DD} \times 0.30$		
Input Low Voltage	V_{IL2}	Hysteresis input			0	$V_{DD} \times 0.25$		
	V _{IL4}	Key-on Wake-up input				$V_{DD} \times 0.65$		
	fc	XIN, XOUT	$V_{DD} = 4.5 \text{ to}$	5.5 V		8.0	16.0	
Clock Frequency		lata and deal	\		fc = 8 MHz	8.0	12.0	MHz
	f _{OSC} Internal clock		$V_{DD} = 4.5 \text{ to } 5.5 \text{ V}$ fc = 16 MHz	16.0	24.0			

Note 1: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

Note 2: Clock frequency fc; Supply voltage range is specified in NORMAL mode and IDLE mode.

Note 3: Smaller value is alternatively specified as the maximum value.

DC Characteristics

 $(V_{SS} = 0 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Pins	Conditions	Min	Тур.	Max	Unit
Hysteresis Voltage	V_{HS}	Hysteresis inputs		-	0.9	-	٧
	I _{IN1}	TEST	V _{DD} = 5.5 V, V _{IN} = 5.5 V/0 V	-	-	± 2	
land Comment	I _{IN2}	Open drain ports	V _{DD} = 5.5 V, V _{IN} = 5.5 V/0 V	-	-	± 2	
Input Current	I _{IN3}	Tri-state ports	V _{DD} = 5.5 V, V _{IN} = 5.5 V/0 V	_	-	± 2	μΑ
	I _{IN4}	RESET, STOP	V _{DD} = 5.5 V, V _{IN} = 5.5 V/0 V	-	-	± 2	
Input Resistance	R _{IN2}	RESET	V _{DD} = 5.5 V, V _{IN} = 0 V	100	220	450	kΩ
Output Leakage	I _{LO1}	Sink open drain ports	V _{DD} = 5.5 V, V _{OUT} = 5.5 V	-	-	2	
Current	I _{LO2}	Tri-state ports	$V_{DD} = 5.5 \text{ V}, \ V_{OUT} = 5.5 \text{ V}/0 \text{ V}$	-	-	± 2	μA
Output High Voltage	V _{OH2}	Tri-state ports	$V_{DD} = 4.5 \text{ V}, I_{OH} = -0.7 \text{ mA}$	4.1	-	-	
Output Low Voltage	V _{OL}	Except XOUT and ports P60 to P63	V _{DD} = 4.5 V, I _{OL} = 1.6 mA		_	0.4	V
Output Low current	I _{OL3}	Port P60 to P63	$V_{DD} = 4.5 \text{ V}, \ V_{OL} = 1.0 \text{ V}$	_	20	-	
Supply Current in NORMAL mode			V _{DD} = 5.5 V fc = 16 MHz (Note3)	_	25	30	mA
Supply Current in IDLE mode	I _{DD}	_	V _{IN} = 5.3 V/0.2 V	_	20	25	
Supply Current in STOP mode			V _{DD} = 5.5 V V _{IN} = 5.3 V/0.2 V	-	0.5	10	μΑ

Note 1 : Typical values show those at Topr = 25° C , V_{DD} = 5 V.

Note 2 : Input Current I_{IN3} ; The current through resistor is not included.

Note 3: Supply Current I_{DD}; The current (Typ. 0.5 mA) through ladder resistors of ADC is included in NORMAL mode and IDLE mode.

AD Conversion Characteristics

 $(V_{SS} = 0 \text{ V}, V_{DD} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}, Topr = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit	
Analog Reference Voltage	V _{AREF}	supplied from V _{DD} pin.	-	V _{DD}	_		
	V _{ASS}	supplied from V _{SS} pin.	_	0	_] ,,	
Analog Reference Voltage Range	△V _{AREF}	$=V_{DD}-V_{SS}$	-	V _{DD}	=	V	
Analog Input Voltage	V _{AIN}		V _{SS}	_	V _{DD}		
Nonlinearity Error			_	_	± 1		
Zero Point Error			_	_	± 2		
Full Scale Error		$V_{DD} = 0.5 V$	-	_	± 2	LSB	
Total Error			_	_	±3		

Note: The total error means all error except quanting error.

AC characteristics

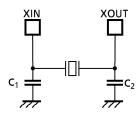
 $(V_{SS} = 0 \text{ V}, V_{DD} = 4.5 \text{ to } 5.5 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
Marshina Guda Tima		In NORMAL mode	0.5		1.0	
Machine Cycle Time	t _{cy}	In IDLE mode	0.5	_	1.0	μS
High Level Clock Pulse Width	t _{WCH}	For external clock operation	31.25	-	_	ns
Low Level Clock Pulse Width	t _{WCL}	(XIN input), fc = 16 MHz	31.23			1,13

Recommended oscillating conditions

 $(V_{SS} = 0 \text{ V}, V_{DD} = 4.5 \text{ to } 5.5 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter Oscillator	Qualification.	Oscillation	December ded Occillator		Recommended Constant		
	Frequency	Recon	nmended Oscillator	C ₁	C ₂		
High-frequency	Ceramic Resonator	8 MHz	Murata	CSA8.00MTZ	30 pF	30 pF	
Osillation		16 MHz	Murata	CSA16.00MXZ040	5 pF	5 pF	



High-frequency Oscillation

- Note 1: To keep reliable operation, shield the device electrically with the metal plate on its package mold surface against the high electric field, for example, by CRT (Cathode Ray Tube).
- Note 2: The product numbers and specifications of the resonators by Murata Manufacturing Co., Ltd. are subject to change. For up-to-date information, please refer to the following URL;
 - http://www.murata.co.jp/search/index.html

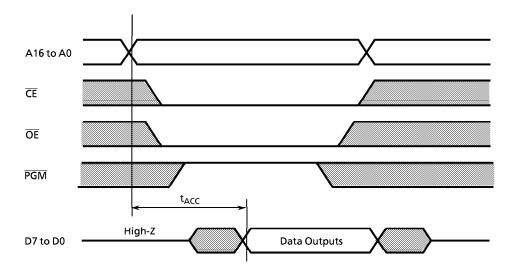
D.C./A.C. Characteristics (PROM mode)

 $(V_{SS} = 0 V)$

(1) Read operation $(V_{DD} = 5.0 \pm 0.25 \text{ V}, \text{Topr} = 25 \pm 5^{\circ}\text{C})$

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
Input High Voltage (A0 to A16, CE, OE, PGM)	V _{IH4}		VDD×0.7	-	VDD	
Input Low Voltage (A0 to A16, CE, OE, PGM)	V _{IL4}		0	-	0.8	V
Program Power Supply Voltage	V _{PP}		4.75	5.0	5.25	
Address Access Time	t _{ACC}		_	1.5tcyc + 300	_	ns

Note: tcyc = 400 ns at 10 MHz

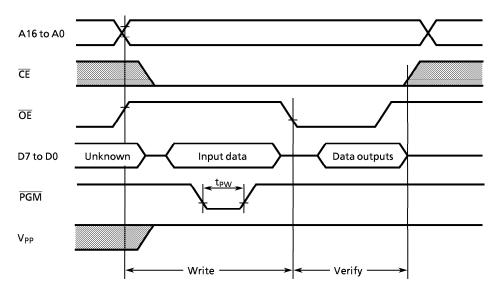


(2) High-speed programming operation

 $(Topr = 25 \pm 5^{\circ}C, VDD = 6.25 \pm 0.25 V)$

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
Input High Voltage (D0 to D7, A0 to A16, CE, OE, PGM)	V _{IH4}		VDD × 0.7	-	VDD	
Input Low Voltage (D0 to D7, A0 to A16, CE, OE, PGM)	V _{IL4}		0	-	0.8	V
Program Power Supply Voltage	V _{PP}		12.5	12.75	13.0	
Initial Program Pulse Width	t _{PW}	V _{DD} = 6.0 V	0.095	0.1	0.105	ms

High-speed Programing Timing



Note1: When V_{cc} power supply is turned on or after, V_{pp} must be increased. When V_{cc} power supply is turned off or before, V_{pp} must be increased.

Note2: The device must not be set to the EPROM programmer or picked op from it under applying the program voltage (12.75 V \pm 0.25 V) to the V_{pp} pin as the device is damaged.

Note3: Be sure to execute the Recommended programing mode with the Recommended programing adaptor. If a mode or an adaptor except the above, the misoperation sometimes occurs.